

FR480 - ELECTRO INSULATING RESIN MAXIMUM OPERATING

Eli-Cast FR480 A slow setting two component, ambient temperature curing Epoxy casting Resin very low shrinkage, excellent dielectrics strength, low heat development, resistant to corrosion.

Suggested applications.

PCB Encapsulation - Electronic components - Encapsulation/Potting - Transformers - Mechanical protection.

TEMP 75°C

Mixing and Application

APPLICATION:	By pouring	
VISCOSITY / 25°C:	Pourable, free flowing liquid	
	Resin: 9 500 – 10 000 mPa.s	
	Hardener: 350 – 400 mPa.s	
COLOUR:	Resin: Black	
	Hardener: Clear Brownish	
	Mixed: Black	
MIXING RATIO:	By Weight:	By Volume:
	100 parts of Resin	100 ccs of Resin
	20 parts of Hardener	28 ccs of Hardener
SPECIFIC GRAVITY / 25°C:	Resin: 1.6 – 1.65 g/cm³	
	Hardener: 0.9 – 1.0 g/cm³	
	Mixed Resin:1.45 g/cm³	
PACKAGING:	2.25kg	

Technical data sheets & MSDS available on request





50 min



SETTING TIME



 $4 - 4\frac{1}{2}$ Hours